

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
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CHRISTOF WEBER	11/12/2019
AXEL BEYER	11/12/2019
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Property Type	Number
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NAME OF SUBMITTER:	WILLIAM G. CONGER
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DATE SIGNED:	12/19/2019
Total Attachments: 2	
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**ASSIGNMENT AND DECLARATION (37 C.F.R. 1.63) FOR UTILITY OR DESIGN
APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76)****Title of Invention** **METHOD, CONTROL SYSTEM AND PLANT FOR PROCESSING A
SEMICONDUCTOR WAFER, AND SEMICONDUCTOR WAFER**

As a below named inventor, I hereby declare that:

This declaration is directed to:

☐ The attached application, or☒ United States application or PCT international application numberPCT/EP2018/064735 filed on June 5, 2018 (I hereby authorize the
insertion of the application filing date and number when they become known.)

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I am aware of the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to
patentability as defined in 37 C.F.R. § 1.56.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I do hereby assign, sell and
set over to SILTRONIC AG, a corporation organized and existing under the laws of the state or country of Germany, and
having a place of business at Hanns-Seidel-Platz 4, 81737 Munich, Germany, hereinafter referred to as the ASSIGNEE, its
successors, assigns or other legal representatives, my entire right, title and interest, domestic and foreign, in and to the inventions
and discoveries in the above-identified application including the right of said ASSIGNEE, its successors, assigns or other legal
representatives to make applications and to receive Letters Patent for said inventions and discoveries in any and all foreign countries
in its or their own name or names, or in my name, at its or their election, and I hereby assign, sell and set over to said ASSIGNEE,
its successors, assigns or other legal representatives, all rights of priority, including any provisional applications, in and to said
inventions and discoveries in all countries, including all applications claiming benefit of the filing date hereof, continuations,
continuations-in-part, divisionals, reexaminations and reissue applications.

And I hereby agree for myself, my heirs, successors, assigns or other legal representatives to execute any and all papers, including
applications for Letters Patent of any and all kinds and in any and all countries and to perform any and all acts which said
ASSIGNEE, its successors, assigns or other legal representatives may deem necessary to secure thereto the rights herein assigned,
sold and set over.

And I hereby represent and warrant that I have not granted any rights inconsistent with the rights granted herein.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or
imprisonment of not more than five (5) years or both.**LEGAL NAME OF INVENTOR**Inventor: Stefan WELSCHDate: 12 November 2019Signature: Stefan Welsch**Page 1 of 2** (Supplemental Sheet with Additional Joint Inventors is attached if necessary)**Note:** An Application Data Sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form.

Attorney Docket Number

WSAGN0155PUSA

**SUPPLEMENTAL SHEET FOR ASSIGNMENT AND
DECLARATION (37 C.F.R. 1.63) FOR UTILITY OR DESIGN
APPLICATION USING AN APPLICATION DATA SHEET
(37 C.F.R. 1.76)**

Additional Inventors
Page 2 of 2

Title of Invention

METHOD, CONTROL SYSTEM AND PLANT FOR PROCESSING A
SEMICONDUCTOR WAFER, AND SEMICONDUCTOR WAFER

Legal Name of Additional Joint Inventor:

Inventor: Christof WEBER

Date: 12. November 2019

Signature:



Legal Name of Additional Joint Inventor:

Inventor: Axel BEYER

Date: 12. Nov. 2019

Signature:

